



#### **DUAL 40V PNP SURFACE MOUNT TRANSISTOR**

#### **Features**

- $V_{CEO} = -40V$
- $I_{C} = -200 \text{mA}$
- **Epitaxial Planar Die Construction**
- Ideally Suited for Automated Assembly Processes
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- **Ultra Small Package**

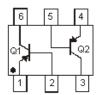
#### **Mechanical Data**

- Case: SOT963
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0027 grams (Approximate)

#### SOT963







**Device Schematic** 

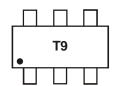
#### **Ordering Information (Note 4)**

| Part Number | Packaging | Shipping           |
|-------------|-----------|--------------------|
| DST3906DJ-7 | SOT963    | 10.000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



T9 = Product Type Marking Code

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## **Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                          | Symbol           | Value | Unit |
|---|------------------|-------|------|
| Collector-Base Voltage                  | $V_{CBO}$        | -40   | V    |
| Collector-Emitter Voltage               | V <sub>CEO</sub> | -40   | V    |
| Emitter-Base Voltage                    | V <sub>EBO</sub> | -5.0  | V    |
| Collector Current - Continuous (Note 5) | Ic               | -200  | mA   |

## **Thermal Characteristics**

| Characteristic                                   | Symbol                            | Value       | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 5)                       | $P_{D}$                           | 300         | mW   |
| Thermal Resistance, Junction to Ambient (Note 5) | $R_{	hetaJA}$                     | 417         | °C/W |
| Operating and Storage Temperature Range          | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

## ESD Ratings (Note 6)

| Characteristic                             | Symbol  | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V    | 3B          |
| Electrostatic Discharge - Machine Model    | ESD MM  | 400   | V    | С           |

Notes: 5. Device mounted on FR-4 PCB with minimum recommended pad layout.

<sup>6.</sup> Refer to JEDEC specification JESD22-A114 and JESD22-A115.



## **Thermal Characteristics and Derating Information**

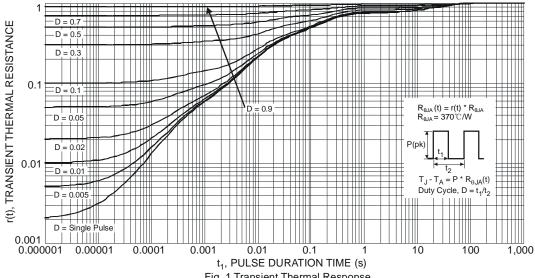


Fig. 1 Transient Thermal Response

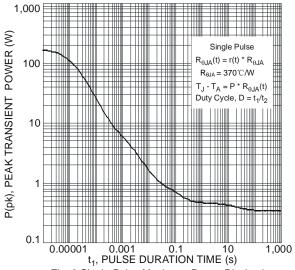


Fig. 2 Single Pulse Maximum Power Dissipation

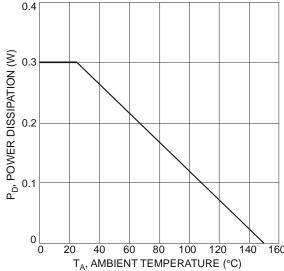


Fig. 3 Power Dissipation vs. Ambient Temperature



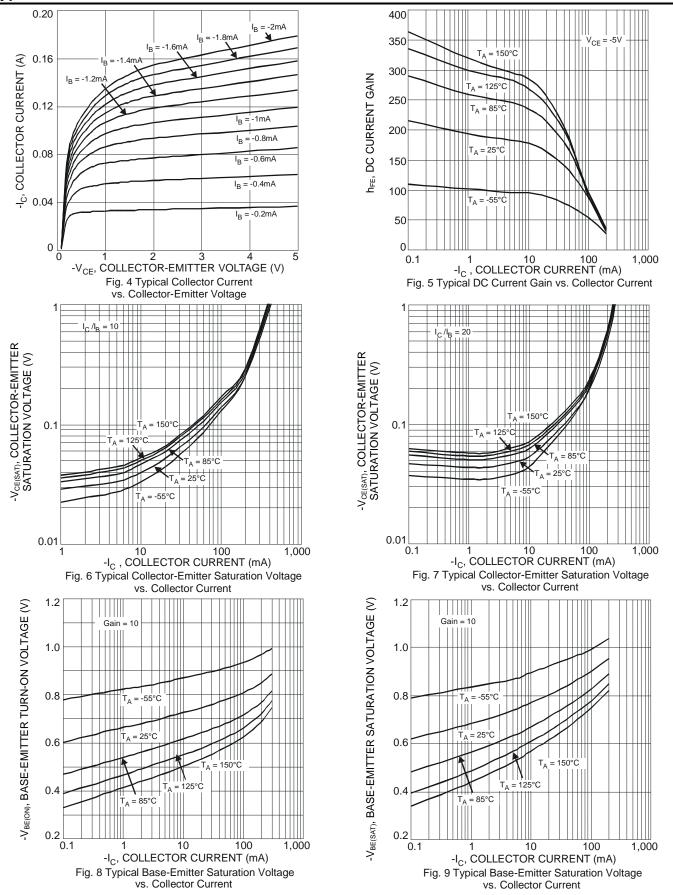
## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol               | Min   | Max   | Unit               | Test Condition                                |
|--|----------------------|-------|-------|--------------------|---|
| OFF CHARACTERISTICS  |                      |       |       |                    |   |
| Collector-Base Breakdown Voltage   | V <sub>(BR)CBO</sub> | -40   |       | V                  | $I_C = -10\mu A, I_E = 0$                     |
| Collector-Emitter Breakdown Voltage (Note 7)   | V <sub>(BR)CEO</sub> | -40   |       | V                  | $I_C = -1 \text{mA}, I_B = 0$                 |
| Emitter-Base Breakdown Voltage   | $V_{(BR)EBO}$        | -6    | _     | V                  | $I_E = -10\mu A, I_C = 0$                     |
| Collector Cutoff Current   | I <sub>CEX</sub>     | _     | -50   | nA                 | $V_{CE} = -30V$ , $V_{EB(OFF)} = -3V$         |
| Collector Cutoff Current   | I <sub>CBO</sub>     | _     | -50   | nA                 | $V_{CB} = -30V, I_{E} = 0$                    |
| Base Cutoff Current  | $I_{BL}$             | _     | -50   | nA                 | $V_{CE} = -30V$ , $V_{EB(OFF)} = -3V$         |
| ON CHARACTERISTICS (Note 7)  |                      |       |       |                    |   |
|  |                      | 60    | _     |                    | $I_C = -100\mu A, V_{CE} = -1V$               |
|  |                      | 80    | _     |                    | $I_C = -1.0 \text{mA}, V_{CE} = -1 \text{V}$  |
| DC Current Gain  | h <sub>FE</sub>      | 100   | 300   | _                  | $I_C = -10$ mA, $V_{CE} = -1$ V               |
|  |                      | 60    | _     |                    | $I_C = -50 \text{mA}, V_{CE} = -1 \text{V}$   |
|  |                      | 30    | _     |                    | $I_C = -100 \text{mA}, V_{CE} = -1 \text{V}$  |
| Collector-Emitter Saturation Voltage   | Variour              | _     | -0.25 | V                  | $I_C = -10mA, I_B = -1mA$                     |
| Concetor Emitter Cataration Voltage  | V <sub>CE(SAT)</sub> |       | -0.40 | V                  | $I_C = -50\text{mA}$ , $I_B = -5\text{mA}$    |
| Base-Emitter Saturation Voltage  | V <sub>BE(SAT)</sub> | -0.65 | -0.85 | V                  | $I_C = -10mA$ , $I_B = -1mA$                  |
| , and the second | V BE(SAT)            | _     | -0.95 |                    | $I_C = -50 \text{mA}, I_B = -5 \text{mA}$     |
| SMALL SIGNAL CHARACTERISTICS   | 1                    |       | ı     | ı                  | 1   |
| Output Capacitance   | C <sub>OBO</sub>     | _     | 4.5   | pF                 | $V_{CB} = -5V$ , $f = 1MHz$ , $I_E = 0$       |
| Input Capacitance  | C <sub>IBO</sub>     |       | 10    | pF                 | $V_{EB} = -0.5V$ , $f = 1MHz$ , $I_{C} = 0$   |
| Input Impedance  | h <sub>ie</sub>      | 2     | 12    | kΩ                 |   |
| Voltage Feedback Ratio   | h <sub>re</sub>      | 0.1   | 10    | x 10 <sup>-4</sup> | $V_{CE} = -10V, I_{C} = -1mA,$                |
| Small Signal Current Gain  | h <sub>fe</sub>      | 100   | 400   | _                  | f = 1kHz                                      |
| Output Admittance  | h <sub>oe</sub>      | 3     | 60    | μS                 |   |
| Current Gain-Bandwidth Product   | f⊤                   | 300   | _     | MHz                | $V_{CE} = -20V, I_{C} = -10mA,$<br>f = 100MHz |
| SWITCHING CHARACTERISTICS  |                      |       |       |                    |   |
| Delay Time   | t <sub>D</sub>       |       | 35    | ns                 | $V_{CC} = -3V, I_{C} = -10mA,$                |
| Rise Time  | t <sub>R</sub>       | _     | 35    | ns                 | $I_{B1} = -1mA$                               |
| Storage Time   | ts                   | _     | 225   | ns                 | $V_{CC} = -3V, I_{C} = -10mA,$                |
| Fall Time  | t <sub>F</sub>       | _     | 75    | ns                 | I <sub>B2</sub> = 1mA                         |

Note: 7. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.

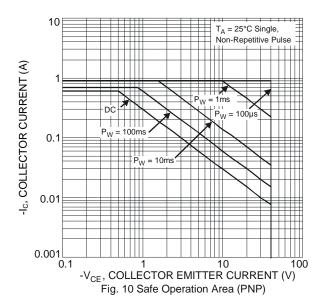


### Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)





# Typical Electrical Characteristics (Cont. @T<sub>A</sub> = +25°C, unless otherwise specified.)

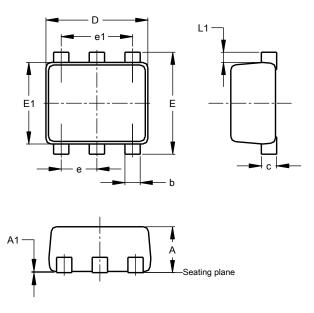




#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT963**

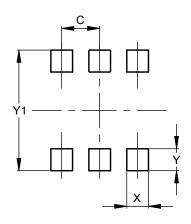


| SOT963               |       |       |       |  |
|----------------------|-------|-------|-------|--|
| Dim                  | Min   | Max   | Тур   |  |
| Α                    | 0.40  | 0.50  | 0.45  |  |
| A1                   | 0.00  | 0.05  |       |  |
| b                    | 0.10  | 0.20  | 0.15  |  |
| С                    | 0.120 | 0.180 | 0.150 |  |
| D                    | 0.95  | 1.05  | 1.00  |  |
| Е                    | 0.95  | 1.05  | 1.00  |  |
| E1                   | 0.75  | 0.85  | 0.80  |  |
| е                    |       |       | 0.35  |  |
| e1                   |       |       | 0.70  |  |
| L1                   | 0.05  | 0.15  | 0.10  |  |
| All Dimensions in mm |       |       |       |  |

## **Suggest Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT963



| Dimensions | Value<br>(in mm) |  |  |
|------------|------------------|--|--|
| С          | 0.350            |  |  |
| Х          | 0.200            |  |  |
| Y          | 0.200            |  |  |
| Y1         | 1.100            |  |  |

Note:

The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These dimensions may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.



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